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Dated: March 16, 2005

Signature: \_\_\_\_\_

(Michael R. Hull)

Docket No.: 29926/39507  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Sung-Kwon Lee

Application No.: 10/660,299

Filed: March 31, 2003

Art Unit: 2818

For: Method for Fabricating Contact Pad of  
Semiconductor Device

Examiner: David Vu

NOA Date: 03/02/2005

**COMMENT ON STATEMENT OF REASONS FOR ALLOWANCE**

MS Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In addition to the reasons for allowance set forth in the allowance papers that were mailed in connection with the present application, it is respectfully submitted that the claims are allowable for the additional reasons that the invention defined by the language of the claims is neither anticipated by, nor would have been obvious when taken as a whole in view of, the art of record.

Dated: March 16, 2005

Respectfully submitted,

By \_\_\_\_\_  
Michael R. Hull

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